

2-382467-1

2-382467-1 Information

Heisener.com	 2-382467-1 TE Connectivity AMP Connectors Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 28POS TIN - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



2-382467-1 Specifications

Manufacturer Part Number2-382467-1ManufacturerEC Connectivity AMP ConnectorsCategoryConnectors, InterconnectsBackageSockets for ICs, TransistorsPackage-SeriesDiplomate DLTypeDIP, 0.6" (15.24mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm) Row SpacingContact Finish - MatinginContact Finish - Mating.Mounting TypeBerylliun CopperMounting TypeOpen FrameFeaturesOpen FramePitch - Post.Contact Finish - Nost.Contact Finish - Nost.Features.Contact Finish - Post.Contact Finish - Post.Contact Finish - Post.Contact Finish - Post.Contact Finish Thickness - Post.Contact Finish Thickness - Post.Contact Finish Thickness - Post.Contact Finish - Post.Contact Finish Thickness - Post.Contact Finish Thickness.Cont			
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Operating Temperature -	Operating Temperature	-	
Report error			Report errors?

2-382467-1 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.



If you have any question about 2-382467-1, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com